# Bluetooth® low energy module Bluetooth® 5.0 low energy EYSHSNZWZ

**Data Report** 

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### **Revision History**

30-Jun.-2017 > Ver.1.0 Release

25-Sep.-2017 > Ver.1.1 Update

15-Dec.-2017 > Ver.1.2 Update

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Control No.		Control name
HD-AG-A160195 (*	1/6)	General Items

### 1. Scope

This specification ("Specification") applies to the hybrid IC "EYSHSNZWZ", a *Bluetooth*® 5.0 low energy module ("Product") manufactured by TAIYO YUDEN Co., Ltd. ("TAIYO YUDEN")

### 2. Description

a) User Code : EYSHSNZWZ Type : EYSHSN

> \*User Code may be changed for mass production or other cases. Note: Please use the User Code (EYSHSNZWZ) to order this product

b) Chip: Nordic nRF52832 (512kB Flash, 64kB RAM)

c) Function : Radio frequency transceiver Module. Bluetooth®5.0 conformity.

d) Application : IoT devices, Health & Fitness Equipment, Sensor, Toys

e) Structure : Hybrid IC loaded with silicon monolithic semiconductor

Containment of hazardous substance in this Product

Can meet with RoHS compliance (Pb, Cd, Hg, Cr+6, PBB, PBDE)

f) Outline: 28-pin Land Grid Array

g) Marking: Part Number, Lot Number, and manufacturer on Shielding Case

h) Country of origin: Japan

i) Packaging : Packaging method: Tape & reel + aluminum moisture barrier bag

Packaging unit: 2000

\*It might be provided as tray at sample stage.

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Control No.		Control name
HD-AG-A160195	(2/6)	General Items

### j) Notes:

### a. Limitation of Warranty

- 1) TAIYO YUDEN provides warranties only if the Product is operated under the condition set forth in this Specification. Please note that TAIYO YUDEN shall not be liable for any defect and/or malfunction arising from use of the Product under the terms and conditions other than the operating conditions hereof. In addition when this Product is used under environmental conditions such as over voltage which is not guaranteed, it may be destroyed in short mode. To ensure the security of customer's product, please add an extra fuse or/and a protection circuit for over voltage.
- 2) This Product is designed for use in products which comply with Bluetooth® Specifications. TAIYO YUDEN disclaims and is not responsible for any liability concerning infringement by this Product under any intellectual property right owned by third party in case the customer uses this Product in any product which does not comply with Bluetooth® Specifications (the "non-complying products"). Furthermore, TAIYO YUDEN warrants only that this Product complies with this Specification and does not grant any other warranty including warranty for application of the non-complying products.
- 3) In some cases, TAIYO YUDEN may use replacements as component parts of Products. Such replacement shall apply only to component part of Products, which TAIYO YUDEN deems it possible to replace or substitute according to (i) Scope of Warranty provided in this specification (e.g. Electric Characteristics, Outline, dimension, Conditions of Use, Reliability Tests, Official Standard (Type Approvals etc.)) and (ii) Quality of Products. TAIYO YUDEN also ensures traceability of such replacement on production lot basis.

### b. Instruction for Use (CAUTION)

- 1) Because Product is not designed for radiation durability, please refrain from exposing Product to radiation in the use.
- 2) Communication between this Product and other might not be established nor maintained depending upon radio environment or operating condition of this Product and other products with wireless technology.
- 3) This Product operates in the unlicensed ISM band at 2.4GHz. In case this Product is used around the other wireless devices which operate in same frequency band of this Product, there is a possibility that interference occurs between this Product and such other devices. If such interference occurs, please stop the operation of other devices or relocate this Product before using this Product or do not use this Product around the other wireless devices.
- 4) This Product mentioned in this Specification is manufactured for use in Health & Fitness Equipment, Sensor, Toys. Before using this Product in any special equipment (such as medical equipment, space equipment, air craft, disaster prevention equipment), where higher safety and reliability are duly required, the applicability and suitability of this Product must be fully evaluated by the customer at its sole risk to ensure correct and safety operation of those special equipments. Also, evaluation of the safety function of this Product even for use in general electronics equipment shall be thoroughly made and when necessary, a protective circuit shall be added in design stage, all at the customer's sole risk.

TAIYO YUDEN CO., LTD.

Control No.		Control name
HD-AG-A160195	(3/6)	General Items

- 5) Japan Regulatory Information
  - a) This Product is a radio system and obtained certification of construction type combined with the specific antenna.
  - b) Please ensure that your product has a label with the following certification mark at easily viewable location. If your product is too small to have the label, please place it in the instruction manual and package of your product. The mark diameter shall be equal or greater than 3mm. In case your product does not have the label with the following certification mark, you or your customer who uses your product may be against the Radio Law and subjected to criminal punishment. TAIYO YUDEN shall not be liable for any loss or damage incurred by you or your customer arising from use of your product which does not have following certification mark.

This product has a radio system which was approved as a radio station in a low power data communication system based on the Radio Law.

EYSHSN: 001-A10996



- 6) Canada Regulatory Information
  - a) This device complies with Industry Canada's applicable licence-exempt RSSs. Operation is subject to the following two conditions:
    - (1) This device may not cause interference; and
    - (2) This device must accept any interference, including interference that may cause undesired operation of the device.

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes :

- 1) l'appareil ne doit pas produire de brouillage;
- 2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.
- b) This product is certified as type of the portable device with Industry Canada Rules. To maintain compliance with RF Exposure requirement, please use within specification of this product.

Ce produit est certifié comme type de l'appareil portable avec Industrie Règles de Canada. Pour maintenir l'acquiescement avec exigence Exposition de RF, veuillez utiliser dans spécification de ce produit.

- IC: 4389B-EYSHSN

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Control No.		Control name
HD-AG-A160195	(4/6)	General Items

c) Please notify certified ID by either one of the following method on your product.

-Contains IC: 4389B-EYSHSN

Specifiez ID certifiée dans votre produit par une de méthode suivante.

-Contains IC: 4389B-EYSHSN

### 7) FCC Regulatory Information

- a) This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.
- b) Please notify certified ID by either one of the following method on your product.
  - -Contains Transmitter Module FCC ID: RYYEYSHSN
  - -Contains FCC ID: RYYEYSHSN
- c) CAUTION: Changes or modifications not expressly approved by the party responsible for compliance could void the use's authority to operate the equipment.
- d) This product is certified as type of the portable device with FCC Rules. To maintain compliance with RF Exposure requirement, please use within specification of this product.
- e) The antenna used for this transmitter must not be co-located or operating in conjunction with any other antenna or transmitter.
- f) This module can change the output power depending on the circumstances by the application software which is developed by module installer. Any end user cannot change the output power.

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Control No.		Control name
HD-AG-A160195	(5/6)	General Items

### 8) CE Regulatory Information

- a) When your end product installs this module, it is required to proceed additional certification processes before placing on the market in EU member states to make your products fully comply with relative EU standards.
- b) TAIYO YUDEN can provide you the test reports of conducted measurement portion for the radio module. You can utilize the test reports for the certification processes of your end product as it requires radio testing.

### c. Term of Support

- 1) In the case that customer requests TAIYO YUDEN to customize the hardware of this Product in order to meet such customer's specific needs, TAIYO YUDEN will make commercially reasonable effort to modify such hardware or software at customer's expense; provide however, the customer is kindly requested to agrees it doesn't mean that TAIYO YUDEN has obligations to do so even in the case it is technically difficult for TAIYO YUDEN.
- 2) Any failure arising out of this Product will be examined by TAIYO YUDEN regardless of before or after mass production. Customer agrees that once such failure is turned out not to be responsible for TAIYO YUDEN after aforesaid examination, some of the technical support shall be conducted by TAIYO YUDEN at customer's expense; provided however, exact cost of this technical support can be agreed through the negotiation by the parties.
- 3) Do not alter hardware and/or software of this Product. Please note that TAIYO YUDEN shall not be liable for any problem if it is caused by customer's alteration of Hardware without Taiyo Yuden's prior approvals.
- 4) TAIYO YUDEN does not guarantee functions and performances which depend on the customer's firmware. TAIYO YUDEN does not assume liabilities for defects and failures (i) in functions, performances and quality of the Customer's product incorporating the Products and (ii) which may occur as the Product is incorporated in the Customer's product.

### d. Caution for Export Control

This Product may be subject to governmental approvals, consents, licenses, authorizations, declarations, filings, and registrations for export or re-export of the Product, required by Japanese Foreign Exchange and Foreign Trade Law (including related laws and regulations) and/or any other country's applicable laws or regulations related to export control.

In case you will export or re-export this Product, you are strongly recommended to check and confirm, before exporting or re-exporting, necessary procedures for export or re-export of this Product which is required by applicable laws and regulations, and if necessary, you have to obtain necessary and appropriate approvals or licenses from governmental authority at your own risk and expense.

### e. Term of Warranty

TAIYO YUDEN warrants only that this Product is in conformity with this Specification for one year after purchase and shall in no event give any other warranty.

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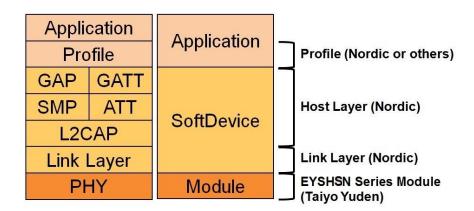
Control No.		Control name
HD-AG-A160195	(6/6)	General Items

### f. Items of the Specification

- 1) Any question arising from the Specification shall be solved in good faith through mutual discussion by the parties hereof.
- 2) The language of this "General items" is Japanese and this "General items" shall be interpreted by Japanese Any copies of translation is a reference purpose only and is not binding on both parties hereto.

### g. Special note

- 1) Taiyo Yuden writes firmware for and fixed SoftDevice (s132\_nrf52\_5.0.0\_softdevice.hex) to this product. Customer writes firmware that is match the customer applications including SoftDevice at the customer's own responsibility.
- 2) The Electrical Characteristics defined in this Specification are of the module with above Firmware (s132\_nrf52\_5.0.0\_softdevice.hex). If other firmware developed by Customer is installed, the characteristics may differ from the defined value in the Electrical Characteristics. Bluetooth qualification and radio type approval may become invalid.
- 3) EYSHSN series module is qualified as PHY only with Component category by Bluetooth SIG. The QDID of this module is 98386. The final product needs to get qualification as End product combining with PHY (module), SoftDevice and Profile before selling the product. The combination of Link and Host layer is differ with SoftDevice. Please refer to following combination and consult with your qualification body and BQE.



TAIYO YUDEN CO., LTD.

Control No.		Control name
HD-AM-A160195 (1	/1)	Absolute maximum ratings

### **Absolute maximum ratings**

Symbol	Parameter	Min.	Max.	Units
VCC_NRF		-0.3	+3.9	V
GND			0	V
VIO, VCC_NRF≤3.6V		-0.3	VCC_NRF+ 0.3	V
VIO, VCC_NRF>3.6V		-0.3	+3.9	V
Storage temperature		-40	+85	Deg-C
MSL	Moisture Sensitivity Level		3	
ESD HBM	Human Body Model		1	kV
ESD MM	Machine Model		100	V
Endurance	Flash Memory Endurance	10000		write/erase cycles
Retention	Flash Memory Retention	10 years		At 40 deg-C
Number of times a 512 byte block can be written between erase cycles	32bit writes		181	times

TAIYO YUDEN CO., LTD.

Control No.		Control name
HD-AE-A160195	(1/3)	Electrical characteristics

### **Electrical characteristics**

### **Recommendation operating range**

Symbol	Parameter	Min.	Тур.	Max.	Units
VCC_NRF	Supply voltage, normal mode	1.7	3.0	3.6	V
tR_VCC_NRF	Supply rise time (0V to 1.7V)*1			60	ms
TA	Operation temperature	-40	25	85	Deg-C

<sup>\*1</sup> The on-chip power-on reset circuitry may not function properly for rise times outside the specified interval. Also after power off, it must start up from below 0.3V. The on-chip power-on reset circuitry may not function properly.

### **DC Specifications**

The Specification applies for Topr.= 25 degrees C, VCC\_NRF = 3.0V

Symbol	Parameter (condition)	Min.	Тур.	Max.	Units
VIH	Input high voltage	0.7 VCC_NRF		VCC_NRF	V
VIL	Input low voltage	GND		0.3 VCC_NRF	V
VOH	Output high voltage (high drive 5 mA)	VCC_NRF-0.4		VCC_NRF	V
VOL	Output low voltage (high drive 5 mA)	GND		GND+0.4	V
RPU	Pull-up resistance	11	13	16	kohm
RPD	Pull-down resistance	11	13	16	kohm
ITX,+4dBm ,DCDC	TX only run current (DCDC, 3V) PRF=+4 dBm		7.5		mA
ITX,+4dBm	TX only run current PRF=+4 dBm		16.6		mA
IRX,1M, DCDC	RX only run current (DCDC, 3V) 1Mbps BLE		5.4		mA
IRX,1M	RX only run current 1Mbps BLE		11.7		mA
IRX,2M, DCDC	RX only run current (DCDC, 3V) 2Msps BLE		5.8		mA
IRX,2M	RX only run current 2Msps BLE		12.9		mA
IOFF	Current in SYSTEM-OFF, no RAM retention		0.3		uA
ION	SYSTEM-ON base current		1.2		uA
IRAM	Additional RAM retention current per 4KB RAM block		20		nA

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Control No.		Control name
HD-AE-A160195 (2	2/3)	Electrical characteristics

### **RF Specifications**

Symbol	Description		Тур.	Max.	Units
Fop	Operating frequencies			2480	MHz
PLLchsp	PLL channel spacing		1		MHz
DfBLE2M	Frequency deviation @ BLE 1Mbps		+/-250		kHz
DfBLE2M	Frequency deviation @ BLE 2Msps		+/-500		kHz
PRF	Maximum output power		4	6	dBm
PRFC	RF power control range 24		24		dB
PRFCR	RF power accuracy			+/-4	dB
PRF1	1st Adjacent Channel Transmit Power 1 MHz		-25		dBc
PRF2	2nd Adjacent Channel Transmit Power 2 MHz		-50		dBc
PRXMAX  Maximum received signal strength at < 0.1% PER		0		dBm	
PSENS,IT,1M,BLE	Receiver sensitivity 1Msps BLE Ideal transmitter <=37bytes (0.1% BER)	tter -94 dB		dBm	
PSENS,IT,2M,BLE	Receiver sensitivity 2Msps BLE Ideal transmitter Packet length<=37bytes	-91		dBm	

### Reference documents for electrical characteristics

### nRF52832\_Product Specification

http://infocenter.nordicsemi.com/topic/com.nordic.infocenter.nrf52/dita/nrf52/chips/nrf52832\_ps.html http://infocenter.nordicsemi.com/pdf/nRF52832\_PS\_v1.4.pdf

### nRF52832\_Rev1 Errata

http://infocenter.nordicsemi.com/topic/com.nordic.infocenter.nrf52/dita/nrf52/errata.html http://infocenter.nordicsemi.com/pdf/nRF52832\_Rev\_1\_Errata\_v1.7.pdf

### S132\_SoftDevice Specification

http://infocenter.nordicsemi.com/topic/com.nordic.infocenter.softdevices52/dita/softdevices/s130/s130.html

http://infocenter.nordicsemi.com/pdf/S132\_SDS\_v5.0.pdf

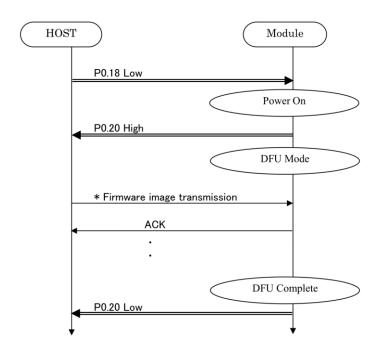
### For more information

https://infocenter.nordicsemi.com/index.jsp

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Control No.		Control name
HD-AE-A160195	(3/3)	Electrical characteristics

### **DFU Specifications**



UART		
Baud rat	e : 38400 bps	UART PIN :
Data : 8 bit		RX : P0.08
Parity : none		TX : P0.06
Stop:1	bit	CTS: P0.07
Hardware	e flow control : Enable	RTS: P0.05

### \* see Nordic Infocenter

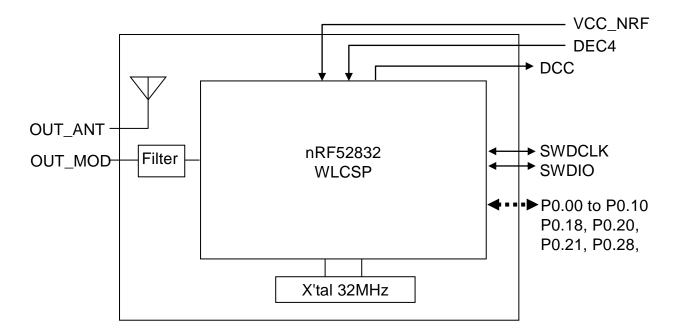
[Nordic Infocenter] http://infocenter.nordicsemi.com/index.jsp Software Development Kit > nRF5 SDK > nRF5 SDK v14.0.0 > Examples > DFU bootloader examples > Serial Secure DFU Bootloader

How to obtain Private (signing) key is attached to evaluation board (EBSHxNZWZ) or evaluation kit (EKSHxNZWZ).

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Control No.		Control name
HD-MC-A160195 (	(1/3)	Circuit Schematic

### **Block Diagram**

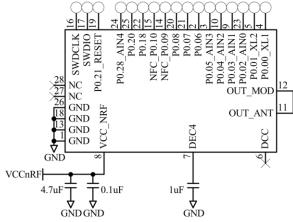


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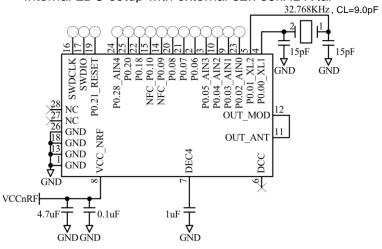
Control No.		Control name
HD-MC-A160195	(2/3)	Circuit Schematic

### Sample circuits

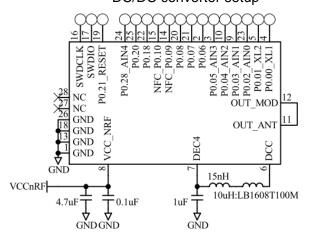
# Internal LDO setup



Internal LDO setup with external 32.768kHz X'tal



### DC/DC converter setup



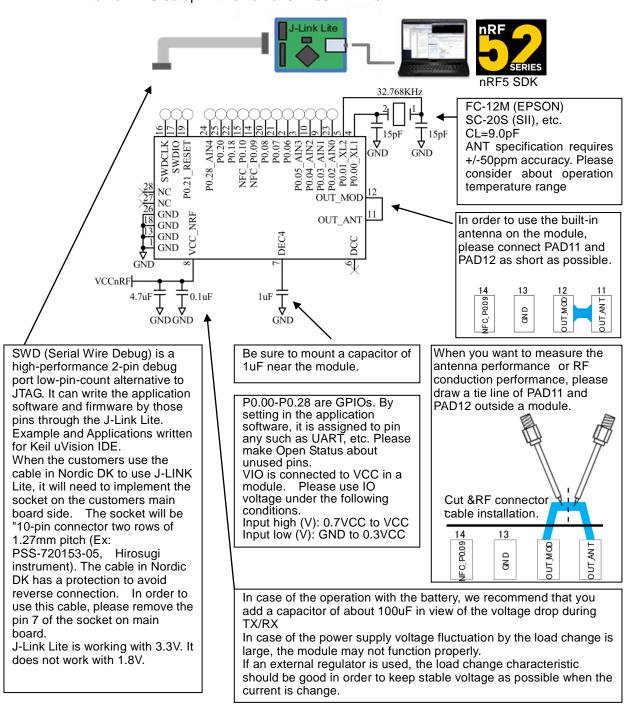
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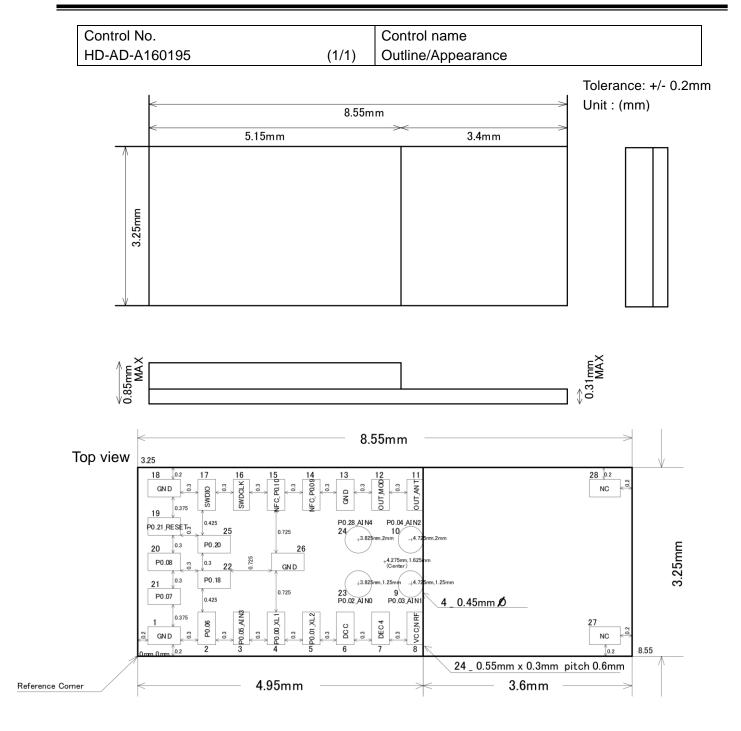
Control No.	Control name
HD-MC-A160195 (3/3)	Circuit Schematic

### **Reference Circuits**

Internal LDO setup with external 32.768kHz X'tal



TAIYO YUDEN CO., LTD.



The dimension of the land pattern is the same as a foot pattern. Recommended metal mask for solder printing

Pad size	Metal mask opening
Square pad 24 – 0.55 x 0.3 mm	0.44 x 0.3 mm
Circle pad 4 – 0.45 mm dia	0.4 mm

The metal mask thickness: t=0.1mm

TAIYO YUDEN CO., LTD.

Control No.		Control name
HD-BA-A160195	(1/2)	Pin Layout

# **Pin Descriptions**

SND	Pin	Pin name	Pin function	Description
P0.05	1	GND	Ground	Ground pin. (0 V)
AlN3 Analog input SAADC/COMP/LPCOMP input.  P0.00 XL1 Analog input Connection for 32.768kHz crystal (LFXO).  P0.01 Digital I/O General purpose I/O pin. XL2 Analog input Connection for 32.768kHz crystal (LFXO).  DCC Power DC/DC converter output pin.  DEC4 Power DC/DC converter output pin.  P0.03 Digital I/O General purpose I/O pin. Analog input to Connection for 32.768kHz crystal (LFXO).  P0.03 Digital I/O General purpose I/O pin. Analog input SAADC/COMP/LPCOMP input.  P0.04 Digital I/O General purpose I/O pin. Analog input SAADC/COMP/LPCOMP input.  P0.04 AIN2 Analog input SAADC/COMP/LPCOMP input.  DUT_ANT Antenna In/Out Internal antenna. It should be connected to Pin 12 OUT_MOD for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  SWD General purpose I/O pin.  Serial Wire Debug clock input for debug and programming  RESET Digital I/O General purpose I/O pin.	2	P0.06	Digital I/O	General purpose I/O pin.
All Analog input SAADC/COMP/LPCOMP input.  P0.00 Digital I/O General purpose I/O pin.  XL1 Analog input Connection for 32.768kHz crystal (LFXO).  P0.01 Digital I/O General purpose I/O pin  XL2 Analog input Connection for 32.768kHz crystal (LFXO).  DCC Power DC/DC converter output pin.  DEC4 Power IV3 regulator supply decoupling. Input from DC/DC converter. Output from 1.3 V LDO.  P0.03 Digital I/O General purpose I/O pin.  AlN1 Analog input SAADC/COMP/LPCOMP input.  P0.04 Digital I/O General purpose I/O pin.  Analog input SAADC/COMP/LPCOMP input.  DUT_ANT Antenna In/Out Internal antenna. It should be connected to Pin 12 OUT_MOD RF In/Out RF I/O pin. It should be connected to Pin 12 OUT_MOD for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  SWDCLK Digital I/O General purpose I/O pin.  Serial Wire Debug clock input for debug and programming  RF I/O Serial Wire Debug I/O for debug and programming  RF I/O Serial Wire Debug I/O for debug and programming  RF I/O Serial Wire Debug I/O pin.  General purpose I/O pin.  General purpose I/O pin.  P0.21 P0.07 Digital I/O General purpose I/O pin.  General purpose I/O pin.  General purpose I/O pin.	2	P0.05	Digital I/O	General purpose I/O pin.
XL1	3	AIN3	Analog input	SAADC/COMP/LPCOMP input.
XL1	1	P0.00	Digital I/O	General purpose I/O pin.
XL2	4	XL1	Analog input	Connection for 32.768kHz crystal (LFXO).
Analog input Connection for 32.768kHz crystal (LFXO).  DCC Power DC/DC converter output pin.  Power Power DC/DC converter output pin.  VCC_NRF Power Power Supply decoupling. Input from DC/DC converter. Output from 1.3 V LDO.  Power Power supply pin.  Analog input SAADC/COMP/LPCOMP input.  Power Power supply pin.  Analog input SAADC/COMP/LPCOMP input.  Internal antenna. It should be connected to Pin 12 OUT_MOD for normal operation.  RF In/Out RF In/Out RF I/O pin. It should be connected to Pin 12 OUT_MOD for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  Seneral purpose I/O pin.  SWD Digital I/O General purpose I/O pin.  SwDCLK Digital I/O Serial Wire Debug clock input for debug and programming  Power supply decoupled as system RESET pin.  (Factory default: RESET)  Digital I/O General purpose I/O pin.  Power supply decoupled as system RESET pin.  (Factory default: RESET)  Power supplied as system RESET pin.  (Factory default: RESET)  Power supplied as system RESET pin.  (Factory default: RESET)	5	P0.01	Digital I/O	General purpose I/O pin
To DEC4 Power 1/3 regulator supply decoupling. Input from DC/DC converter. Output from 1.3 V LDO.  10 P0.03 Digital I/O Analog input SAADC/COMP/LPCOMP input.  10 P0.04 AIN2 Antenna In/Out Internal antenna. It should be connected to Pin 12 OUT_MOD For normal operation.  11 OUT_ANT Antenna In/Out Province Power of Powe	5	XL2	Analog input	Connection for 32.768kHz crystal (LFXO).
DEC4   Power   Input from DC/DC converter. Output from 1.3 V LDO.	6	DCC	Power	DC/DC converter output pin.
Input from DC/DC converter. Output from 1.3 V LDO.	7	DEC4	Power	1V3 regulator supply decoupling.
P0.03	1	DLO4	rowei	Input from DC/DC converter. Output from 1.3 V LDO.
AIN1 Analog input SAADC/COMP/LPCOMP input.  P0.04 Digital I/O General purpose I/O pin. Analog input SAADC/COMP/LPCOMP input.  I1 OUT_ANT Antenna In/Out Internal antenna. It should be connected to Pin 12 OUT_MOD for normal operation.  RF In/Out RF In/Opin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF In/Opin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF In/Opin. It should be connected to Pin 11 OUT_ANT for normal operation.  NFC NFC Input NFC antenna connection. P0.09 Digital I/O General purpose I/O pin.  NFC NFC Input NFC antenna connection. P0.10 Digital I/O General purpose I/O pin.  SWDCLK Digital input Serial Wire Debug clock input for debug and programming  NFC Serial Wire Debug I/O for debug and programming  RESET Digital I/O General purpose I/O pin Configurable as system RESET pin. (Factory default : RESET)  P0.07 Digital I/O General purpose I/O pin.  Digital I/O General purpose I/O pin.	8	VCC_NRF	Power	Power supply pin.
AIN1 Analog input SAADC/COMP/LPCOMP input.  P0.04 AIN2 Analog input SAADC/COMP/LPCOMP input.  OUT_ANT Antenna In/Out Internal antenna. It should be connected to Pin 12 OUT_MOD for normal operation.  OUT_MOD RF In/Out RF In/Out Internal antenna. It should be connected to Pin 12 OUT_MOD for normal operation.  RF In/Out RF In/Op in. It should be connected to Pin 11 OUT_ANT for normal operation.  NFC NFC Input NFC antenna connection.  OP0.09 Digital I/O General purpose I/O pin.  NFC NFC input NFC antenna connection.  OP0.10 Digital I/O General purpose I/O pin.  SWDCLK Digital input Serial Wire Debug clock input for debug and programming  SWDIO Digital I/O Serial Wire Debug I/O for debug and programming  RESET Digital I/O General purpose I/O pin  OP0.21 Configurable as system RESET pin.  (Factory default : RESET)  Digital I/O General purpose I/O pin.  Digital I/O General purpose I/O pin.  OP0.08 Digital I/O General purpose I/O pin.	0	P0.03	Digital I/O	General purpose I/O pin.
AlN2 Analog input SAADC/COMP/LPCOMP input.  Antenna In/Out Internal antenna. It should be connected to Pin 12 OUT_MOD for normal operation.  RF In/Out RF In/Opin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF In/Opin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF In/Opin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF In/Opin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF In/Opin. It should be connected to Pin 11 OUT_ANT for normal operation.  NFC NFC input NFC antenna connection.  General purpose I/O pin.  NFC antenna connection.  General purpose I/O pin.  SWDCLK Digital I/O General Purpose I/O pin.  SWDIO Digital I/O Serial Wire Debug clock input for debug and programming  RESET Digital I/O General purpose I/O pin  Configurable as system RESET pin.  (Factory default : RESET)  P0.07 Digital I/O General purpose I/O pin.	9	AIN1	Analog input	SAADC/COMP/LPCOMP input.
AlN2 Analog input SAADC/COMP/LPCOMP input.  11 OUT_ANT Antenna In/Out OUT_MOD for normal operation.  12 OUT_MOD RF In/Out RF In/Out RF In/Opin. It should be connected to Pin 12 OUT_MOD for normal operation.  13 GND Ground Ground Jin. (0 V)  14 NFC NFC Input NFC antenna connection.  P0.09 Digital I/O General purpose I/O pin.  15 NFC NFC input NFC antenna connection.  P0.10 Digital I/O General purpose I/O pin.  16 SWDCLK Digital input Serial Wire Debug clock input for debug and programming  17 SWDIO Digital I/O Serial Wire Debug I/O for debug and programming  18 GND Ground Ground pin. (0 V)  19 P0.21 RESET Digital I/O General purpose I/O pin  20 P0.08 Digital I/O General purpose I/O pin.  21 P0.07 Digital I/O General purpose I/O pin.  22 P0.18 Digital I/O General purpose I/O pin.  23 General purpose I/O pin.  24 General purpose I/O pin.  25 General purpose I/O pin.  Configurable as system RESET pin.  (Factory default : RESET)  General purpose I/O pin.	10	P0.04	Digital I/O	General purpose I/O pin.
11 OUT_ANT Antenna In/Out OUT_MOD for normal operation.  12 OUT_MOD RF In/Out RF I/O pin. It should be connected to Pin 11 OUT_ANT for normal operation.  13 GND Ground Ground pin. (0 V)  14 NFC NFC Input NFC antenna connection.  15 NFC NFC Input NFC antenna connection.  16 SWDCLK Digital I/O General purpose I/O pin.  17 SWDIO Digital I/O Serial Wire Debug clock input for debug and programming  18 GND Ground Ground pin. (0 V)  19 P0.21 RESET Digital I/O General purpose I/O pin  20 P0.08 Digital I/O General purpose I/O pin.  21 P0.07 Digital I/O General purpose I/O pin.  22 P0.18 Digital I/O General purpose I/O pin.	10	AIN2	Analog input	SAADC/COMP/LPCOMP input.
OUT_MOD RF In/Out RF In/Opin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF In/Opin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF In/Opin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF In/Opin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF In/Opin. It should be connected to Pin 11 OUT_ANT for normal operation.  RF In/Opin. It should be connected to Pin 11 OUT_ANT for normal operation.  NFC	11	OUT ANT	Antenna In/Out	Internal antenna. It should be connected to Pin 12
12 OUT_MOD RF In/Out normal operation.  13 GND Ground Ground pin. (0 V)  14 NFC NFC input NFC antenna connection.  15 NFC NFC input NFC antenna connection.  16 SWDCLK Digital I/O General purpose I/O pin.  17 SWDIO Digital I/O Serial Wire Debug clock input for debug and programming  18 GND Ground Ground pin. (0 V)  19 P0.21 RESET Digital I/O General purpose I/O pin  20 P0.08 Digital I/O General purpose I/O pin.  21 P0.07 Digital I/O General purpose I/O pin.  22 P0.18 Digital I/O General purpose I/O pin.  23 General purpose I/O pin.  24 General purpose I/O pin.  25 General purpose I/O pin.  26 General purpose I/O pin.  27 General purpose I/O pin.  28 General purpose I/O pin.  29 General purpose I/O pin.  20 General purpose I/O pin.  20 General purpose I/O pin.		OUT_AINT		OUT_MOD for normal operation.
13   GND   Ground   Ground pin. (0 V)	12 OUT MOD	OUT MOD	RE In/Out	RF I/O pin. It should be connected to Pin 11 OUT_ANT for
NFC   NFC   nput   Digital I/O   General purpose I/O pin.  NFC   NFC   NFC   nput   Digital I/O   General purpose I/O pin.  NFC   NFC   nput   Digital I/O   General purpose I/O pin.  SWDCLK   Digital input   Serial   Wire   Debug   clock   input   for   debug   and   programming    SWDIO   Digital I/O   Serial   Wire   Debug   I/O   for   debug   and   programming    RESET   Digital I/O   General   purpose I/O   pin    Configurable as system   RESET   pin.   (Factory   default : RESET)    Po.07   Digital I/O   General   purpose I/O   pin.  Po.18   Digital I/O   General   purpose I/O   pin.	12	OO1_WOD	KF III/Out	normal operation.
P0.09 Digital I/O General purpose I/O pin.  NFC NFC input Digital I/O General purpose I/O pin.  NFC antenna connection.  General purpose I/O pin.  SWDCLK Digital input Serial Wire Debug clock input for debug and programming  SWDIO Digital I/O Serial Wire Debug I/O for debug and programming  ROND Ground Ground pin. (0 V)  P0.21 P0.21 Digital I/O General purpose I/O pin Configurable as system RESET pin. (Factory default: RESET)  P0.08 Digital I/O General purpose I/O pin.  P0.07 Digital I/O General purpose I/O pin.	13	GND	Ground	Ground pin. (0 V)
P0.09   Digital I/O   General purpose I/O pin.	11	NFC	NFC input	NFC antenna connection.
P0.10 Digital I/O General purpose I/O pin.  SWDCLK Digital input Programming  Serial Wire Debug clock input for debug and programming  SWDIO Digital I/O Serial Wire Debug I/O for debug and programming  RESET General purpose I/O pin Configurable as system RESET pin. (Factory default : RESET)  Digital I/O General purpose I/O pin.  Digital I/O General purpose I/O pin.  P0.08 Digital I/O General purpose I/O pin.  P0.07 Digital I/O General purpose I/O pin.	14	P0.09	Digital I/O	General purpose I/O pin.
P0.10 Digital I/O General purpose I/O pin.  SwDCLK Digital input Serial Wire Debug clock input for debug and programming  SwDIO Digital I/O Serial Wire Debug I/O for debug and programming  Reset Digital I/O General purpose I/O pin Configurable as system RESET pin. (Factory default : RESET)  Digital I/O General purpose I/O pin. Digital I/O General purpose I/O pin.  P0.07 Digital I/O General purpose I/O pin.	15	NFC	NFC input	NFC antenna connection.
16 SWDCLK Digital input programming  17 SWDIO Digital I/O Serial Wire Debug I/O for debug and programming  18 GND Ground Ground pin. (0 V)  19 P0.21 General purpose I/O pin Configurable as system RESET pin. (Factory default : RESET)  20 P0.08 Digital I/O General purpose I/O pin.  21 P0.07 Digital I/O General purpose I/O pin. P0.18 Digital I/O General purpose I/O pin.	13	P0.10	Digital I/O	General purpose I/O pin.
programming  17 SWDIO Digital I/O Serial Wire Debug I/O for debug and programming  18 GND Ground Ground pin. (0 V)  19 P0.21 RESET Digital I/O General purpose I/O pin Configurable as system RESET pin. (Factory default : RESET)  20 P0.08 Digital I/O General purpose I/O pin.  21 P0.07 Digital I/O General purpose I/O pin.  P0.18 Digital I/O General purpose I/O pin.	16	SWDCLK	Digital input	Serial Wire Debug clock input for debug and
18 GND Ground Ground pin. (0 V)  P0.21 RESET Digital I/O General purpose I/O pin  Configurable as system RESET pin. (Factory default : RESET)  P0.08 Digital I/O General purpose I/O pin.  P0.07 Digital I/O General purpose I/O pin.  P0.18 Digital I/O General purpose I/O pin.	10	OWDOLK	Digital Input	programming
P0.21 RESET  Digital I/O  Configurable as system RESET pin. (Factory default : RESET)  P0.08  Digital I/O  General purpose I/O pin.  General purpose I/O pin.  P0.07  Digital I/O  General purpose I/O pin.  P0.18  Digital I/O  General purpose I/O pin.  General purpose I/O pin.	17	SWDIO	Digital I/O	Serial Wire Debug I/O for debug and programming
19 P0.21 RESET Digital I/O Configurable as system RESET pin. (Factory default : RESET)  20 P0.08 Digital I/O General purpose I/O pin.  21 P0.07 Digital I/O General purpose I/O pin.  P0.18 Digital I/O General purpose I/O pin	18	GND	Ground	Ground pin. (0 V)
Digital I/O Configurable as system RESET pin. (Factory default : RESET)  Po.08 Digital I/O General purpose I/O pin.  Po.07 Digital I/O General purpose I/O pin.  Po.18 Digital I/O General purpose I/O pin.		D0 21		General purpose I/O pin
P0.08 Digital I/O General purpose I/O pin.  P0.07 Digital I/O General purpose I/O pin.  P0.18 Digital I/O General purpose I/O pin.  General purpose I/O pin.	19		Digital I/O	Configurable as system RESET pin.
21 P0.07 Digital I/O General purpose I/O pin. P0.18 Digital I/O General purpose I/O pin		RESET		(Factory default : RESET)
P0.18 Digital I/O General purpose I/O pin	20	P0.08	Digital I/O	General purpose I/O pin.
	21	P0.07	Digital I/O	General purpose I/O pin.
TRACEDATA[0] Trace port output.	22	P0.18	Digital I/O	General purpose I/O pin
		TRACEDATA[0]		Trace port output.

TAIYO YUDEN CO., LTD.

Control No.		Control name
HD-BA-A160195	(2/2)	Pin Layout

Pin	Pin name	Pin function	Description
22	P0.02	Digital I/O	General purpose I/O pin.
23	AIN0	Analog input	SAADC/COMP/LPCOMP input.
24	P0.28	Digital I/O	General purpose I/O pin.
24	AIN4	Analog input	SAADC/COMP/LPCOMP input.
25	P0.20	Digital I/O	General purpose I/O pin.
25	TRACECLK		Trace port clock output.
26	GND	Ground	Ground pin. (0 V)
27	NC	Not Connected	Isolated pad on PCB for mechanical stability.
28	NC	Not Connected	Isolated pad on PCB for mechanical stability.

TAIYO YUDEN CO., LTD.

Control No.		Control name
HQ-BA-537	(1/2)	Handling Precaution

This specification describes desire and conditions especially for mounting.

### Desire/Conditions

### (1) Environment conditions for use and storage

- Store the components in an environment of < <u>40deg-C/90%RH</u> if they are in a moisture barrier bag packed by TAIYO YUDEN.
- 2. Keep the factory ambient conditions at < 30deg-C/60%RH.
- 3. Store the components in an environment of < 25±5deg-C/10%RH after the bag is opened. (The condition is also applied to a stay in the manufacture process).

### (2) Conditions for handling of products

Make sure all of the moisture barrier bags have no holes, cracks or damages at receiving. If an abnormality is found on the bag, its moisture level must be checked in accordance with 2 in (2).

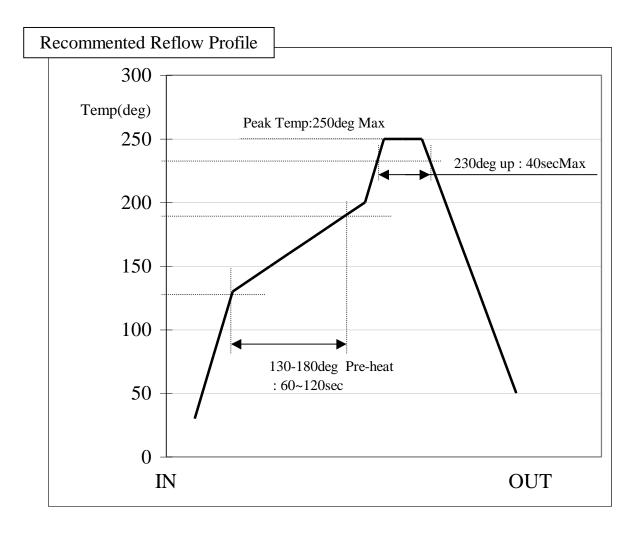
Refer to the label on the bag.

- 1. All of the surface mounting process (reflow process) must be completed <u>in 12 months</u> from the bag sea date.
- 2. Make sure humidity in the bag is less than **10%RH** immediately after open, using a humidity indicator card sealed with the components.
- 3. <u>All</u> of the surface mounting process (reflow process including rework process) must be completed in **168 hours** after the bag is opened (inclusive of any other processes).
- 4. If any conditions in (1) or condition 2 and 3 in (2) are not met, bake the components in accordance with the conditions at <u>125deg-C 24hours</u>
- 5. As a rule, baking the components in accordance with conditions 4 in (2) shall be once.
- Since semi-conductors are inside of the components, they must be free from static electricity while handled.(<100V) Use ESD protective floor mats, wrist straps, ESD protective footwear, air ionizers etc., if necessary.
- 7. Please make sure that there are lessen mechanical vibration and shock for this module, and do not drop it.
- 8. Please recognize pads of back side at surface mount.
- 9. Washing the module is not recommended. If washing cannot be avoided, please test module functionality and performance after thoroughly drying the module. We cannot be held responsible for any failure due washing the module.
- 10. Please perform temperature conditions of module at reflow within the limits of the following.

Please give the number of times of reflow as a maximum of 2 times.

TAIYO YUDEN CO., LTD.

Control No.		Control name
HQ-BA-537	(2/2)	Handling Precaution



TAIYO YUDEN CO., LTD.

Control No.		Control name
HD-BB-A160195	(1/3)	Packaging Specification

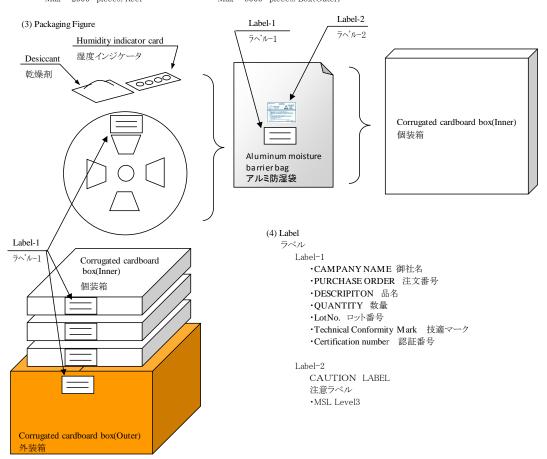
Packaging Specification

Packaging Specification 梱包仕様

梱包材料 (1) Packaging Material Name Outline Materials 備考 部材名 概要 材質 16mm wide - 8mmPitch Emboss Conductive PS エンボス 16mm幅 - 8mmピッチ 導電性 PS Cover Tape φ 330 mm Conductive PS Reel リール 導電性 PS Desiccant 30g×1 乾燥剤 Humidity indicator card 湿度インジケータ Aluminum moisture barrier bag 420×460(mm) (AS)PET/AL/NY/PE(AS) アルミ防湿袋 Label ラベル Corrugated cardboard box(Inner)  $339 \times 351 \times 74 \text{(mm)}$ Corrugated cardboard box(Outer)  $369 \times 369 \times 277 \text{(mm)}$ 外装箱

(2) Packaging Unit 梱包数量

Max 2000 pieces/Reel Max 6000 pieces/Box(Outer)

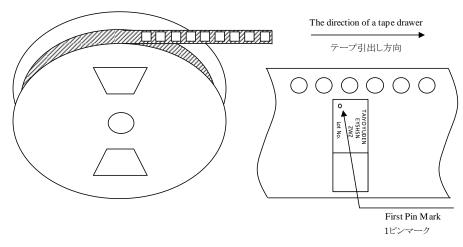


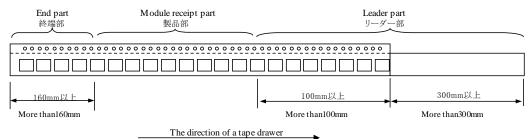
TAIYO YUDEN CO., LTD.

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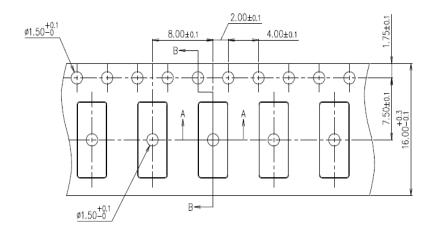
Control No.		Control name
HD-BB-A160195	(2/3)	Packaging Specification



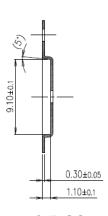




キャリアエンボス図面



テープ引き出し方向



Section B-B



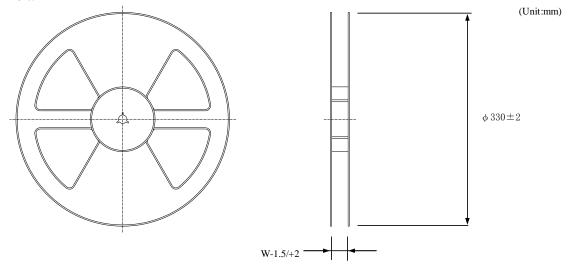
TAIYO YUDEN CO., LTD.

TAIYO YUDEN CO., LTD.

Control No.		Control name
HD-BB-A160195	(3/3)	Packaging Specification

### Reel specification

リール仕様



Tape wide	8mm	12mm	16mm	24mm	32mm	44mm
W	9.4mm	13.4mm	17.4mm	25.4mm	33.4mm	45.4mm

### Taping performance

テーピング性能

Both of an embossing tape top cover tape bear this, when the power of 10N is applied in the direction of a drawer.

・エンボステープ、トップカバーテープともに、引き出し方向に10Nの力を加えた場合に、これに耐えうること.

The exfoliation adhesion of a top cover tape is the intensity of  $0.1 \sim 1.3 N$ .

(The angle to pull is  $165 \sim 180$  degrees. The speed to pull is 300 mm/min.)

・トップカバーテープの剥離強度は、角度165~180度に保ち、300mm/minのスピードでトップカバーテープを引っ張ったとき、0.1~1.3Nとする.

### Note

備考

Lack of the parts in 1 reel is with two or less pieces.

1リール中の部品の欠落は2個までとします。(ラベル表示数量と梱包数は同じです。欠落とはテープ内でのモジュール抜けが2個まで許容させていただくという意味になります。)

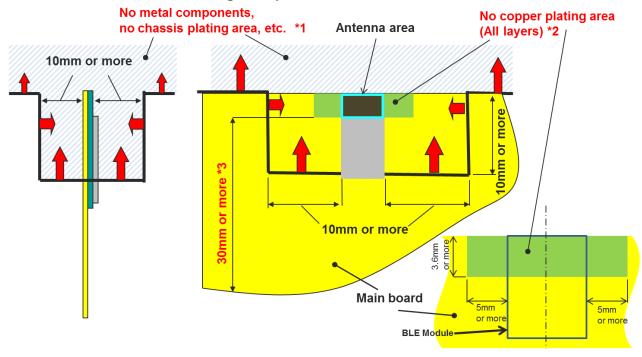
MSL Level 3 Under control MSL はレベル3で管理しています。

# TAIYO YUDEN CO., LTD.

TAIYO YUDEN CO., LTD.

Control No.	Control name
(1/3)	Antenna application note

### Recommended module mounting example



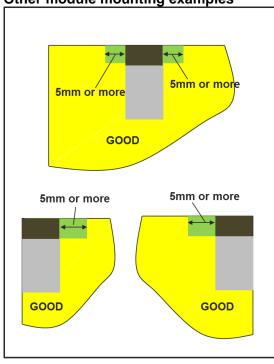
- \*1 Please do not place any metal components in blue shaded space,(\*1) such as signal line and metal chassis as possible except for main board while mounting the components in \*1 space on the main board is allowed except for no copper plating area. (\*2).
- \*2 This area is routing prohibited area on the main board. Please do not place copper on any layer. Please remain use of FR-4 dielectric material. The antenna is tuned with the FR-4.
- \*3 Characteristics may deteriorate when GND pattern length is less than 30mm. It should be 30 mm or more as possible.

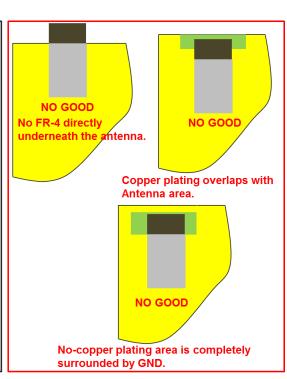
Even when above mentioned condition is satisfied, communication performance may be significantly deteriorated depending on the structure of the product.

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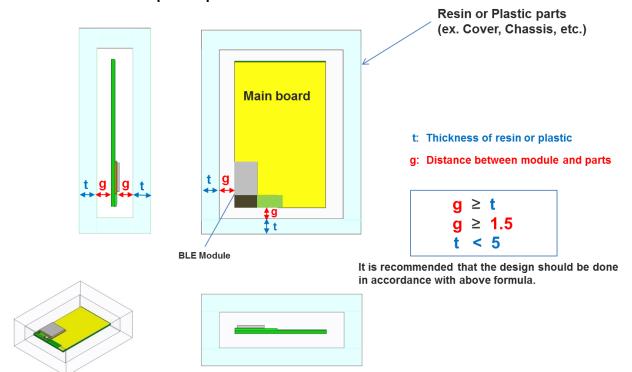
Control No.	Control name
(2/3)	Antenna application note

Other module mounting examples





### Placement of resin or plastic parts



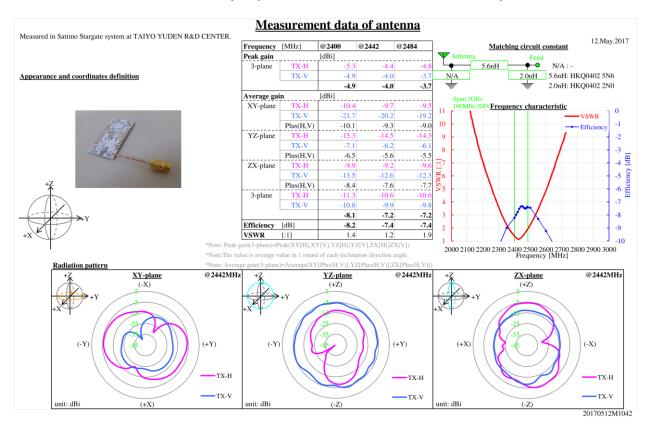
Please do not apply molding over the antenna area of BLE module.

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Control No.	Control name
(3/3)	Antenna application note

### Directional characteristics example (when mounted on evaluation board)



### **About this Application Note**

- •This Application Note has been prepared as a reference material to help obtaining the antenna performance mounted on BLE module better while it is not guaranteed or assured to obtain better communication performance and distance.
- •This product "BLE module" has been certified and matching circuit constant for antenna within module cannot be changed when ambient environment condition changes. The product must be re-certified when matching circuit constant is changed.

TAIYO YUDEN CO., LTD.

Control No.	Control name
(1/2)	Design guide

### 1. Power Up Sequence

VCC\_NRF power supply rise time (0V to 1.7V) must not exceed 60ms.

### 2. Recommended Power Circuit

VCC\_NRF is the main power supply (1.7-3.6V) for this module. The supply voltage range of VCC\_NRF is 1.7V to 3.6V in both of LDO and DCDC mode. In case of the power supply voltage fluctuation by the load change is large, the module may not function properly. If an external regulator is used, the load change characteristic should be good in order to keep stable voltage as possible when the current is change.

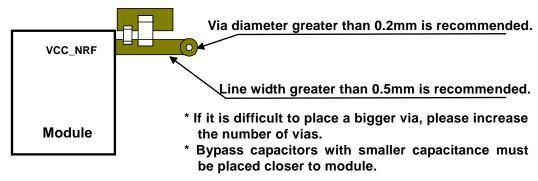
### 3. Battery operation

When using a small battery (e.g. CR2032), a large capacitor (e.g.100uF low leakage capacitor) should be placed near the battery. This will reduce the voltage drop especially when the module is operated at low temperatures

### 4. Pattern Design Guide

### 4-1. Power Supply System

Power supply bypass capacitors should be placed close to the VCC\_NRF pin of the module. The VCC\_NRF trace should be greater than 0.5mm and a bigger a via diameter is recommended.

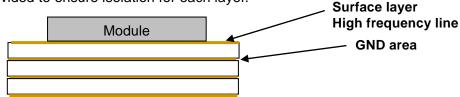


### 5.0. Bypass Capacitor Layout

A parallel combination of a small capacitance (about 10pF) and a large capacitance (1uF to 10uF) is recommended for bypass capacitors. The GND of the bypass capacitor should be placed close to an adjacent module GND to ensure the shortest closed loop.

### 4-3. GND Pattern

Power supply bypass capacitor GND should be placed in proximity of module GND. Wide GND area must be provided to ensure isolation for each layer.



GND pattern of each layer should be connected to GND area with large number of via.

TAIYO YUDEN CO., LTD.

Control No.	Control name
(2/2)	Design guide

# Reference information

EYSHSN Series may be able to develop the extremely slim product such as pen, chopsticks, glasses frames, ring, slim wrist band and so on.



### Example of our demonstration board. (Not for sale)

3. 65mm x 35. 6mm

U1 BLE CN1 \_ S10 \_ 2.54mm pitch

2-Layers board L/S: 100/100(um)

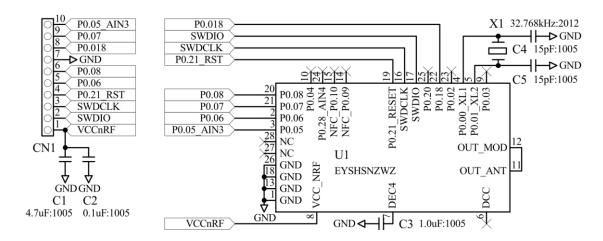
TH/Land: 250/500(um)

Solder resist opening: +50(um)

Board outline to Circuit pattern: 300(um)

Board outline to TH: 625(um)

Even in the case of a small product, please take the GND pattern that kept strong in any layer for antenna performance.



TAIYO YUDEN CO., LTD.

Control No.	Control name
(1/1)	Notes

### 32kHz Clock

This module does not installed 32.768kHz crystal. In case of operating without external crystal, please use following example code in order to enable internal 32.768kHz RC oscillator (32k RCOSC).

```
nrf_clock_lf_cfg_t clock_lf_cfg;
clock_lf_cfg.rc_ctiv = 16;
clock_lf_cfg.rc_temp_ctiv = 2;
clock_lf_cfg.source = NRF_CLOCK_LF_SRC_RC;
clock_lf_cfg.xtal_accuracy = NRF_CLOCK_LF_XTAL_ACCURACY_250_PPM;
SOFTDEVICE_HANDLER_APPSH_INIT(&clock_lf_cfg, true);
```

Note that when you choose to use the RC oscillator, it will add around 2uA average current consumption compared to a 20ppm external crystal.

ANT specification requires +/-50ppm accuracy for 32.768kHz clock. There is a possibility that the internal RC oscillator does not meet to the specification.

### その他、注意事項について (Precautions)

- 弊社製品のご使用に際しては、使用する機器に実装された状態および実際の使用環境での評価および確認を必ず行ってください。
- 当仕様書に記載の製品は、一般的な電子機器【AV 機器、OA 機器、家電製品、事務機器、情報・通信機器(携帯電話、パソコンなど)】で使用されることを意図されています。従いまして、生命または身体に直接危害を及ぼす可能性のある機器【輸送用機器(自動車駆動制御装置、列車制御装置、船舶制御装置など)、交通用信号機器、防災機器、医療用機器、公共性の高い情報通信機器(電話交換機、電話・無線・放送などの基地局)】などへのご使用をご検討の場合は、必ず事前に弊社までお問い合わせをお願いします。

また、高度の安全性や信頼性が求められる機器【宇宙用機器、航空用機器、原子力用制御機器、海底用機器、軍事用機器など】につきましては、弊社製品をご使用されないようお願いします。

なお、一般的な電子機器においても安全性や信頼性の要求が高い機器、回路などに弊社製品をご使用になる場合には、十分な安全性評価を 実施され、必要に応じて設計時に保護回路などを追加していただくことをお勧めします。

弊社の書面による事前の承諾を得ることなく、前述の弊社への問い合わせが必要な機器または弊社が使用を禁止する機器に当仕様書に記載の製品を使用したことによりお客様または第三者に生じた損害に関して、弊社は一切の責任を負いかねますのでご了承ください。

- 弊社製品を使用したことにより、第三者の知的財産権などの権利に関わる問題が発生した場合、弊社はその責任を負いかねます。また、これらの権利の実施権許諾を行うものではありませんのでご了承ください。
- 弊社製品の保証範囲につきましては、別途書面による契約がない限り、納入された弊社製品単体の保証に限られ、弊社製品の故障や瑕疵から誘発される損害に関して、弊社は一切の責任を負いかねますのでご了承ください。
- 当仕様書の記載内容につきましては、弊社の営業所・販売子会社・販売代理店(いわゆる「正規販売チャンネル」)からご購入いただいた 弊社製品に適用します。上記以外からご購入いただいた弊社製品に関しては適用対象外とさせていただきますのでご了承ください。
- 輸出注意事項

当仕様書に記載の製品の一部には、輸出の際に「外国為替及び外国貿易法」並びに米国の輸出管理関連法規などの規制をご確認の上、必要な手続きをお取りいただく必要のある製品があります。ご不明な場合には弊社までお問い合わせください。

- Please conduct validation and verification of our products in actual condition of mounting and operating environment before using our products.
- The products listed in this specification are intended for use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment including, without limitation, mobile phone, and PC). Please be sure to contact TAIYO YUDEN for further information before using the products for any equipment which may directly cause loss of human life or bodily injury (e.g., transportation equipment including, without limitation, automotive powertrain control system, train control system, and ship control system, traffic signal equipment, disaster prevention equipment, medical equipment, highly public information network equipment including, without limitation, telephone exchange, and base station).

Please do not incorporate our products into any equipment requiring high levels of safety and/or reliability (e.g., aerospace equipment, aviation equipment, nuclear control equipment, undersea equipment, military equipment).

When our products are used even for high safety and/or reliability-required devices or circuits of general electronic equipment, it is strongly recommended to perform a thorough safety evaluation prior to use of our products and to install a protection circuit as necessary.

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this specification for any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

- Please note that TAIYO YUDEN shall have no responsibility for any controversies or disputes that may occur in connection with a third party's intellectual property rights and other related rights arising from use of our products. TAIYO YUDEN grants no license for such rights.
- Please note that unless otherwise agreed in writing, the scope of warranty for our products is limited to the delivered our products themselves and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a fault or defect in our products.
- The contents of this specification are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this specification are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.
- Caution for Export

Some of our products listed in this specification may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.